ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan-	C, Bannockb	urn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declar he declaration	ation of the encompass	substances es all lowe	within the n er level mater	nanufacture rials for wh	er listed ite hich the ma	m. Note: nufacture	if the item is an as er has engineering	ssembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distr				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				ous Materia	als and Mfg Information				
Supplier Information														
Company name* Con			Company unique ID			Unique ID Authority					Response Date*			
semi									2024-05-16					
ntact Name Title - Contact			ct	Ţ			Phone - Contact*				Email - Contact*			
roduct-Env-Stewards Product Envi			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represen			sentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Env			act Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		mber Mfr Item Name			Effective Da	te Version	Version Manufacturing Site		ng Site	W	eight*	UOM	Unit Type
	CAT410	9V-GT2	LED DR, 3CH RGB PWM			2024-05-16			PH1		12	9.66	mg	Each
Aanufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Mat	Aterial Terminal Base		Alloy	y J-STD-020 MSL Ratir		Peak Pro	Process Body Temperature		re Max Tin	ne at Peak '	k Temperature N		ber of Reflow Cy	cles
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		C	30		second	3		
omments														
vel 1 - maximum time at peak temperatu	e during sol	dering is 10-3	0 seconds											
or more information regarding material o	omposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.53	mg	Supplier	Silicon (Si)	7440-21-3		3.53	mg
Die Attach	0.44	mg	Supplier	Silver (Ag)	7440-22-4		0.33	mg
			Supplier	Epoxy resins	129915-35-1		0.11	mg
Lead Frame	49.81	mg	Supplier	Zinc (Zn)	7440-66-6		0.0498	mg
			Supplier	Iron (Fe)	7439-89-6		1.1456	mg
			Supplier	Copper (Cu)	7440-50-8		48.5648	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0498	mg
Mold Compound-Black	75.04	mg		Epoxy Phenol Resin	proprietary data		7.8792	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		67.1608	mg
Plating	0.58	mg	Supplier	Palladium (Pd)	7440-05-3		0.0361	mg
			В	Nickel (Ni)	7440-02-0		0.5377	mg
			Supplier	Gold (Au)	7440-57-5		0.0062	mg
Wire Bond - Au	0.26	mg	Supplier	Gold (Au)	7440-57-5		0.26	mg